Method and device for electrolytically increasing the thickness of an electrically conductive pattern on a dielectric substrate, as well as a dielectric substrate.

A B S T R A C T

The invention provides a method for electrolytically increasing the thickness of an electrically conductive pattern on a dielectric substrate, comprising the steps of

- immersing the substrate with the pattern present thereon in an electrolytic bath,
- electrically contacting in the electrolytic bath a negatively charged electrode with the pattern during immersion of the substrate, and
- effecting contacting movement in the electrolytic bath of the electrode and the pattern with respect to each other during immersion of the substrate.

The invention furthermore provides a device for electrolytically increasing the thickness of an electrically conductive pattern on a dielectric substrate.

Fig. 1